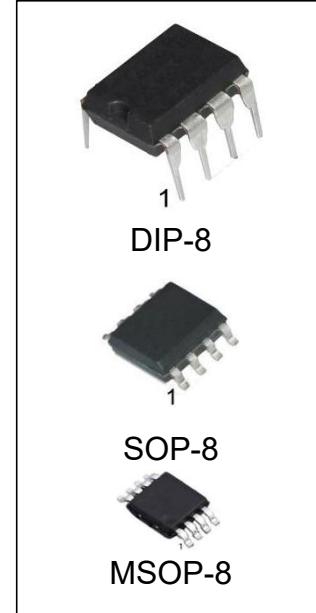


## **DIFFERENTIAL TRANSCEIVER WITH TRANSIENT VOLTAGE SUPPRESSION**

### **FEATURES**

- Integrated Transient Voltage Suppression
- ESD Protection for Bus Terminals Exceeds:
  - ±30 kV IEC 61000-4-2, Contact Discharge
  - ±15 kV IEC 61000-4-2, Air-Gap Discharge
  - ±15 kV EIA/JEDEC Human Body Model
- Circuit Damage Protection of 400-W Peak (Typical) Per IEC 61000-4-5
- Controlled Driver Output-Voltage Slew Rates Allow Longer Cable Stub Lengths
- 250-kbps in Electrically Noisy Environments
- Open-Circuit Fail-Safe Receiver Design
- 1/4 Unit Load Allows for 128 Devices Connected on Bus
- Thermal Shutdown Protection
- Power-Up/-Down Glitch Protection
- Each Transceiver Meets or Exceeds the Requirements of TIA/EIA-485 (RS-485) and ISO/IEC 8482:1993(E) Standards
- Low Disabled Supply Current 300  $\mu$ A Max
- Pin Compatible With SN75176
- Applications:
  - Industrial Networks
  - Utility Meters
  - Motor Control



### **ORDERING INFORMATION**

<b>DEVICE</b>	<b>Package Type</b>	<b>MARKING</b>	<b>Packing</b>	<b>Packing Qty</b>
SN65LBC184N	DIP-8	65LBC184	TUBE	2000pcs/box
SN65LBC184M/TR	SOP-8	6LB184,65LBC184	REEL	2500pcs/reel
SN65LBC184MM/TR	MSOP-8	6LB184	REEL	3000pcs/reel
SN75LBC184N	DIP-8	75LBC184	TUBE	2000pcs/box
SN75LBC184M/TR	SOP-8	7LB184,75LBC184	REEL	2500pcs/reel
SN75LBC184MM/TR	MSOP-8	7LB184	REEL	3000pcs/reel

## DESCRIPTION

The SN75LBC184 and SN65LBC184 are differential data line transceivers in the trade-standard footprint of the SN75176 with built-in protection against high-energy noise transients. This feature provides a substantial increase in reliability for better immunity to noise transients coupled to the data cable over most existing devices. Use of these circuits provides a reliable low-cost direct-coupled (with no isolation transformer) data line interface without requiring any external components.

The SN75LBC184 and SN65LBC184 can withstand overvoltage transients of 400-W peak (typical). The conventional combination wave called out in IEC 61000-4-5 simulates the overvoltage transient and models a unidirectional surge caused by overvoltages from switching and secondary lightning transients.

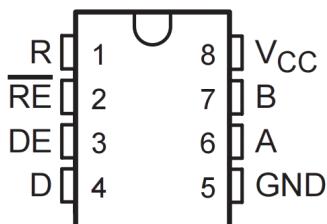
A biexponential function defined by separate rise and fall times for voltage and current simulates the combination wave. The standard 1.2  $\mu$ s/50 $\mu$ s combination waveform is shown in Figure 1 and in the test description in Figure 15.

The device also includes additional desirable features for party-line data buses in electrically noisy environment applications including industrial process control. The differential-driver design incorporates slew-rate-controlled outputs sufficient to transmit data up to 250 kbps. Slew-rate control allows longer unterminated cable runs and longer stub lengths from the main backbone than possible with uncontrolled and faster voltage transitions. A unique receiver design provides a fail-safe output of a high level when the inputs are left floating (open circuit). The SN75LBC184 and SN65LBC184 receiver also includes a high input resistance equivalent to one-fourth unit load allowing connection of up to 128 similar devices on the bus.

The SN75LBC184 is characterized for operation from 0°C to 70°C. The SN65LBC184 is characterized from -40°C to 85°C.

## PIN CONFIGURATION

DIP-8/SOP-8/MSOP-8



## FUNCTIONAL LOGIC DIAGRAM (POSITIVE LOGIC)

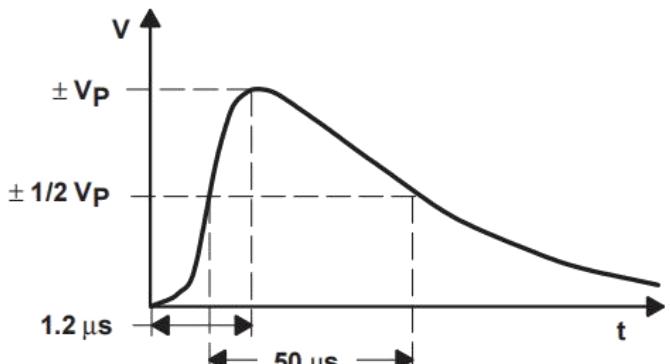
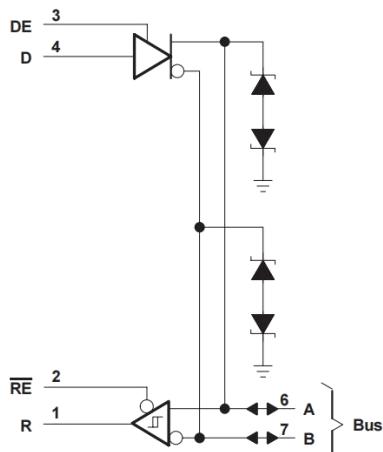
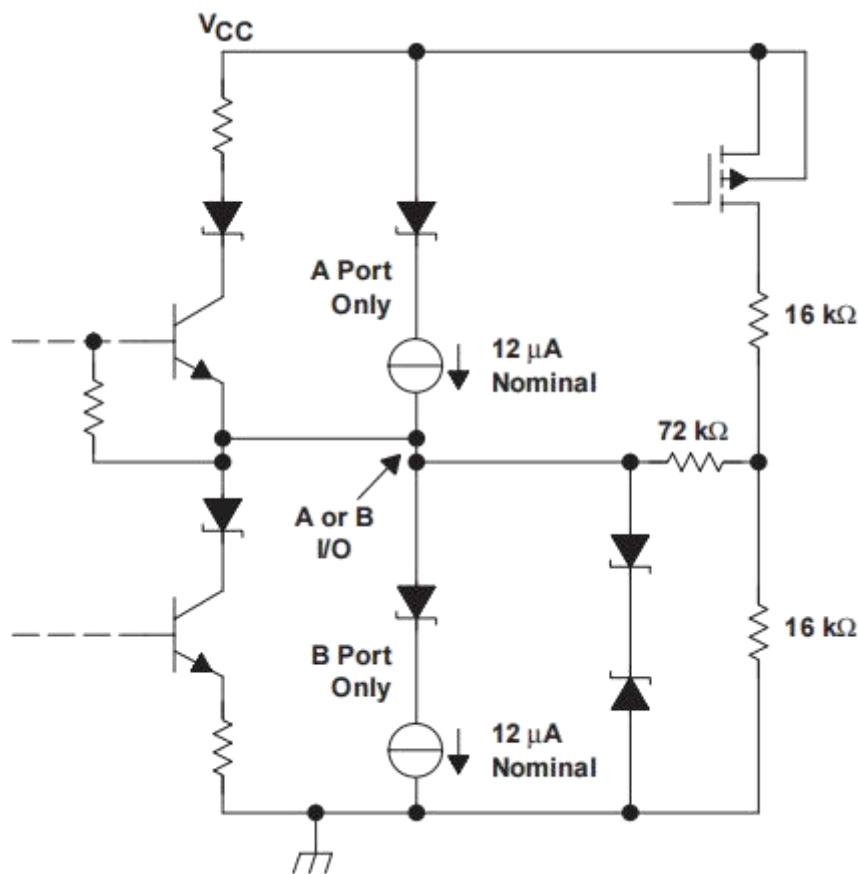


Figure 1. Surge Waveform — Combination Wave

## SCHEMATIC OF INPUTS AND OUTPUTS



## DRIVER FUNCTION TABLE

INPUT	ENABLE	OUTPUTS	
D	DE	A	B
H	H	H	L
L	H	L	H
X	L	Z	Z

H = high level, L = low level, ? = indeterminate,

X = irrelevant, Z = high impedance (off)

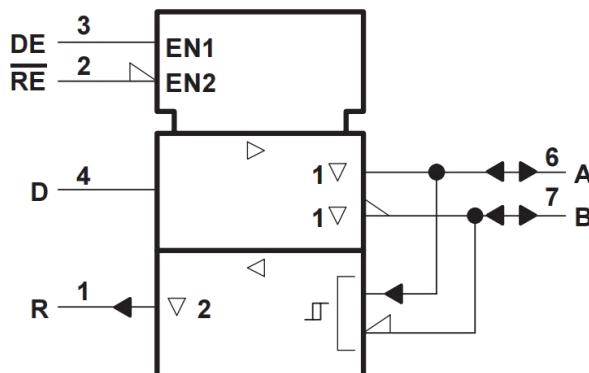
## RECEIVER FUNCTION TABLE

DIFFERENTIAL INPUTS	ENABLE	OUTPUT
A - B	$\overline{RE}$	R
$V_{ID} \geq 0.2V$	L	H
$-0.2V < V_{ID} < 0.2V$	L	?
$V_{ID} \leq -0.2V$	L	L
X	H	Z
Open	L	H

H = high level, L = low level, ? = indeterminate,

X = irrelevant, Z = high impedance (off)

## LOGIC SYMBOL



This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

Condition	Min	Max
Supply voltage, VCC (see Note 1)	-0.5V	7V
Continuous voltage range at any bus terminal	-15V	15V
Data input/output voltage	-0.3	7
Receiver output current, IO	-20mA	+20mA
Electrostatic discharge:		
Contact discharge (IEC61000-4-2) A,B,ND (see Note 2)	-	30KV
Air discharge (IEC61000-4-2) A,B,ND (see Note 2)	-	15KV
Human body model (see Note 3) A,B,ND (see Note 2)	-	15KV
All pins	-	3KV
All terminals (Class 3A) (see Note 2)	-	8KV
All terminals (Class 3A) (see Note 2)	-	1200V
Continuous total power dissipation (see Note 4)	Internally Limited	
Lead Temperature (Soldering, 10 seconds)	260°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### NOTES:

1. All voltage values, except differential input/output bus voltage, are with respect to network ground terminal.
2. GND and bus terminal ESD protection is beyond readily available test equipment capabilities for IEC 61000-4-2, EIA/JEDEC test method A114-A and MIL-STD-883C method 3015. Ratings listed are limits of test equipment; device performance exceeds these limits.
3. Tested in accordance with JEDEC Standard 22, Test Method A114-A.
4. The driver shuts down at a junction temperature of approximately 160°C. To operate below this temperature, see the Dissipation Rating Table.

## DISSIPATION RATING TABLE

PACKAGE	TA ≤ 25°C POWER RATING	DERATING FACTOR ABOVE TA = 25°C	TA = 70°C POWER RATING	TA = 85°C POWER RATING
N	725 mW	5.8 mW/°C	464 mW	377 mW
M	1150 mW	9.2 mW/°C	736 mW	598 mW

## RECOMMENDED OPERATING CONDITIONS

		MIN <sup>(2)</sup>	TYP	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.75	5	5.25	V
Voltage at any bus terminal (separately or common mode), V <sub>I</sub> or V <sub>IC</sub>		-7		12	V
High-level input voltage, V <sub>IH</sub>		2			V
Low-level input voltage, V <sub>IL</sub>			0.8		V
Differential input voltage,  V <sub>ID</sub>			12		V
High-level output current, I <sub>OH</sub>	Driver	-60			mA
	Receiver	-8			mA
Low-level output current, I <sub>OL</sub>	Driver		60		mA
	Receiver		4		
Operating free-air temperature, TA	SN75LBC184	0	70		°C
	SN65LBC184	-40	85		°C

(2) The algebraic convention, in which the less-positive (more-negative) limit is designated minimum, is used in this data sheet.

## DRIVER SECTION

**electrical characteristics over recommended operating conditions (unless otherwise noted)**

PARAMETER	ALTERNATE SYMBOLS	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I <sub>CC</sub> Supply current	NA	DE = $\bar{RE}$ = 5 V, No Load	12	25		mA
		DE = 0 V, $\bar{RE}$ = 5 V, No Load	175	300		$\mu$ A
I <sub>IH</sub> High-level input current (D, DE, $\bar{RE}$ )	NA	V <sub>I</sub> = 2.4 V		50		$\mu$ A
I <sub>IL</sub> Low-level input current (D, DE, $\bar{RE}$ )	NA	V <sub>I</sub> = 0.4 V	-50			$\mu$ A
I <sub>OS</sub> Short-circuit output current (see Note 5)	NA	V <sub>O</sub> = -7 V	-250	-120		mA
		V <sub>O</sub> = V <sub>CC</sub>		250		
		V <sub>O</sub> = 12 V		250		
I <sub>OZ</sub> High-impedance output current	NA			See Receiver II		mA
V <sub>O</sub> Output voltage	V <sub>oa</sub> , V <sub>ob</sub>	I <sub>O</sub> = 0	0	V <sub>CC</sub>		V
V <sub>OC(PP)</sub> Peak-to-peak change in common-mode output voltage during state transitions	NA	See Figures 5 and 6		0.8		V
V <sub>OC</sub> Common-mode output voltage	V <sub>os</sub>	See Figure 4	1	3		V
$\Delta V_{OC(SS)}$   Magnitude of change, common-mode steady-state output voltage	V <sub>os</sub> - $\bar{V}_{os}$	See Figure 5		0.1		V
V <sub>OD</sub>   Magnitude of differential output voltage  V <sub>A</sub> - V <sub>B</sub>	V <sub>O</sub>	I <sub>O</sub> = 0	1.5	6		V
		R <sub>L</sub> = 54Ω, See Figure 4	1.5			V
$\Delta  V_{OD} $ Change in differential voltage magnitude between logic states	V <sub>t</sub> - $\bar{V}_t$	R <sub>L</sub> = 54Ω		0.1		V

All typical values are measured with TA = 25°C and V<sub>CC</sub> = 5 V.

NOTE 5: This parameter is measured with only one output being driven at a time.

**switching characteristics over recommended operating conditions (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>d(DH)</sub> Differential output delay time, low-to-high-level output	R <sub>L</sub> = 54Ω, C <sub>L</sub> = 50 pF, See Figure 5	1.3			$\mu$ s
t <sub>d(DL)</sub> Differential-output delay time, high-to-low-level output		1.3			$\mu$ s
t <sub>PLH</sub> Propagation delay time, low-to-high-level output		0.5	1.3		$\mu$ s
t <sub>PHL</sub> Propagation delay time, high-to-low-level output		0.5	1.3		$\mu$ s
t <sub>sk(p)</sub> Pulse skew (  t <sub>d(DH)</sub> - dt (DL)  )		75	150		ns
t <sub>r</sub> Rise time, single ended		0.25	1.2		$\mu$ s
t <sub>f</sub> Fall time, single ended		0.25	1.2		$\mu$ s
t <sub>PZH</sub> Output enable time to high level	R <sub>L</sub> = 110Ω See Figure 2		3.5		$\mu$ s
t <sub>PZL</sub> Output enable time to low level	R <sub>L</sub> = 110Ω See Figure 3		3.5		$\mu$ s
t <sub>PHZ</sub> Output disable time from high level	R <sub>L</sub> = 110Ω See Figure 2		2		$\mu$ s
t <sub>PLZ</sub> Output disable time from low level	R <sub>L</sub> = 110Ω See Figure 3		2		$\mu$ s

## RECEIVER SECTION

electrical characteristics over recommended operating conditions (unless otherwise noted)

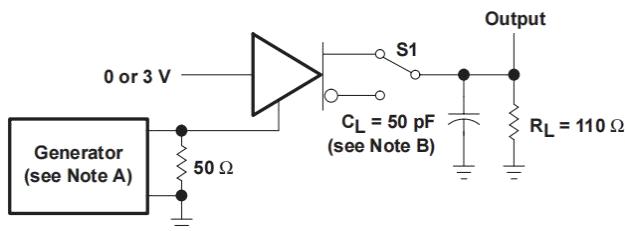
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I <sub>CC</sub> Supply current (total package)	DE = $\bar{RE}$ = 0 V, No Load			3.9	mA
	$\bar{RE}$ = 5 V, No Load, DE = 0 V, No Load			300	$\mu$ A
I <sub>I</sub> Input current	Other input = 0 V	V <sub>I</sub> = 12 V		250	A
		V <sub>I</sub> = 12 V V <sub>CC</sub> = 0		250	
		V <sub>I</sub> = -7V		-200	
		V <sub>I</sub> = -7V V <sub>CC</sub> = 0		-200	
I <sub>OZ</sub> High-impedance-state output current	VO = 0.4 V to 2.4 V			$\pm$ 100	$\mu$ A
V <sub>hys</sub> Input hysteresis voltage				70	mV
V <sub>IT+</sub> Positive-going input threshold voltage				200	mV
V <sub>IT-</sub> Negative-going input threshold voltage				-200	mV
V <sub>OH</sub> High-level output voltage	I <sub>OH</sub> = -8 mA Figure 7			2.8	V
V <sub>OL</sub> Low-level output voltage	I <sub>OL</sub> = 4 mA Figure 7			0.4	V

All typical values are at V<sub>CC</sub> = 5 V, TA = 25°C.

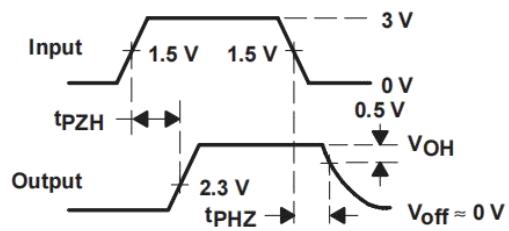
switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>PLH</sub> Propagation delay time, low-to-high-level output	C <sub>L</sub> = 50 pF, See Figure 7			150	ns
t <sub>PHL</sub> Propagation delay time, high-to-low-level output				150	ns
t <sub>sk(p)</sub> Pulse skew ( t <sub>pHL</sub> - t <sub>PLH</sub>  )				50	ns
t <sub>r</sub> Rise time, single ended	See Figure 7			20	ns
t <sub>f</sub> Fall time, single ended				20	ns
t <sub>PZH</sub> Output enable time to high level	See Figure 8			100	ns
t <sub>PZL</sub> Output enable time to low level				100	ns
t <sub>PHZ</sub> Output disable time from high level				100	ns
t <sub>PLZ</sub> Output disable time from low level				100	ns

## PARAMETER MEASUREMENT INFORMATION



## TEST CIRCUIT

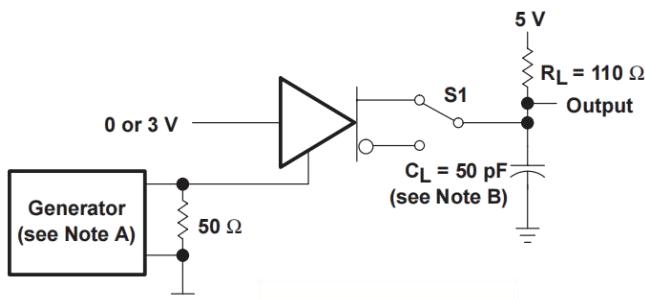


## VOLTAGE WAVEFORMS

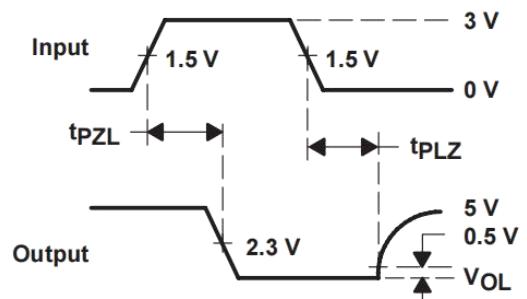
## NOTES:

- A. The input pulse is supplied by a generator having the following characteristics: PRR = 1.25 kHz, 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns,  $Z_0 = 50 \Omega$ .
- B. CL includes probe and jig capacitance.

Figure 2. Driver  $t_{PZH}$  and  $t_{PHZ}$  Test Circuit and Voltage Waveforms



## TEST CIRCUIT

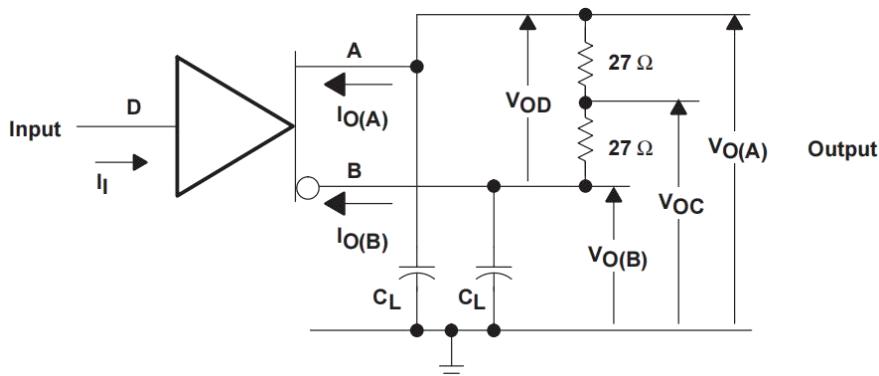


## VOLTAGE WAVEFORMS

## NOTES:

- A. The input pulse is supplied by a generator having the following characteristics: PRR = 1.25 kHz, 50% duty cycle,  $tr \leq 10 \text{ ns}$ ,  $tf \leq 10 \text{ ns}$ ,  $ZO = 50 \Omega$ .
- B. CL includes probe and jig capacitance.

Figure 3. Driver  $t_{PZL}$  and  $t_{PLZ}$  Test Circuit and Voltage Waveforms



## NOTES:

- A. Resistance values are in ohms and are 1% tolerance.
- B.  $C_L$  includes probe and jig capacitance.

Figure 4. Driver Test Circuit, Voltage, and Current Definitions

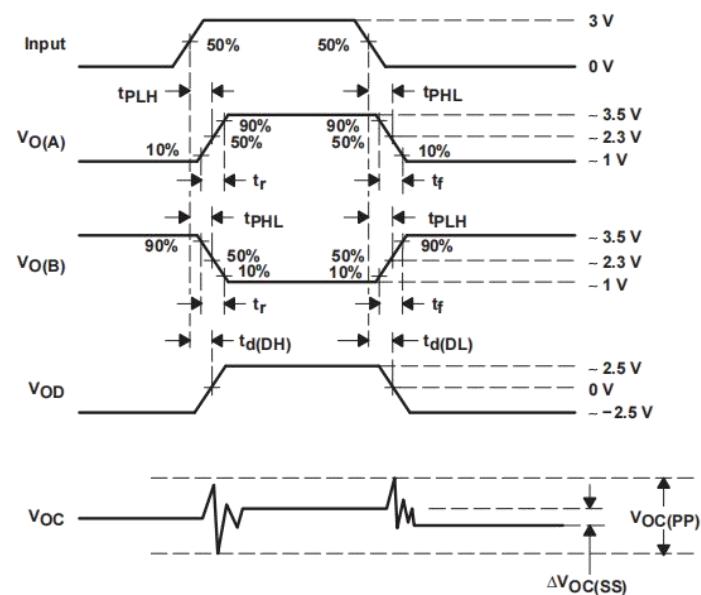
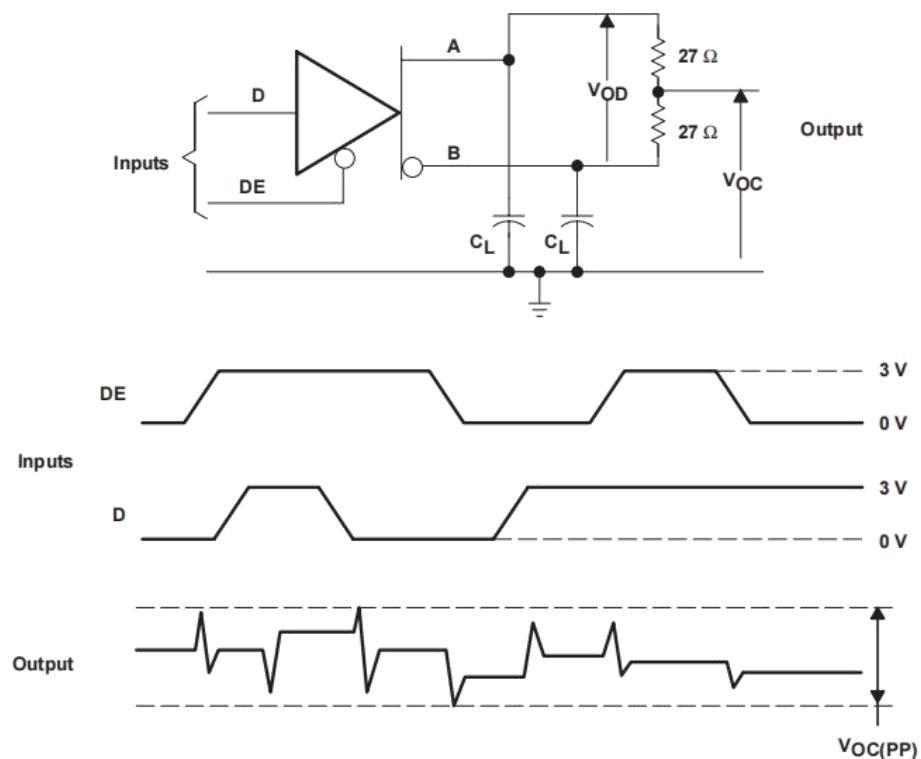
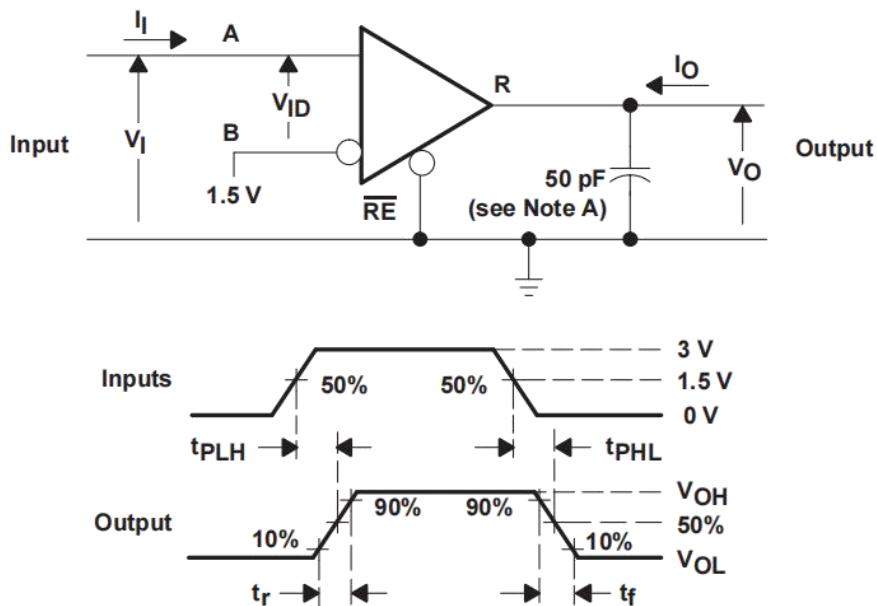
**PARAMETER MEASUREMENT INFORMATION**


Figure 5. Driver Timing, Voltage and Current Waveforms

**PARAMETER MEASUREMENT INFORMATION**

**NOTES:**

- Resistance values are in ohms and are 1% tolerance.
- CL includes probe and jig capacitance ( $\pm 10\%$ ).

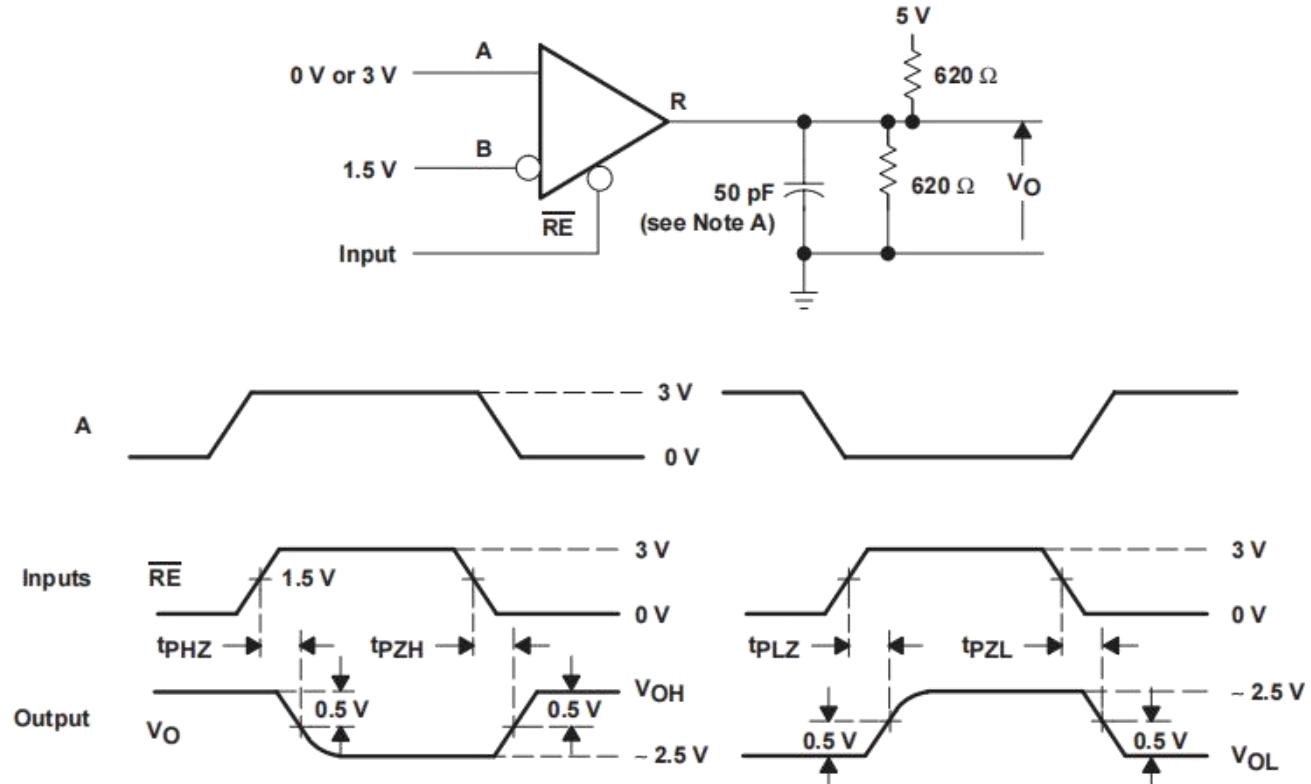
Figure 6. Driver  $V_{OC(PP)}$  Test Circuit and Waveforms



NOTEA: This value includes probe and jig capacitance ( $\pm 10\%$ ).

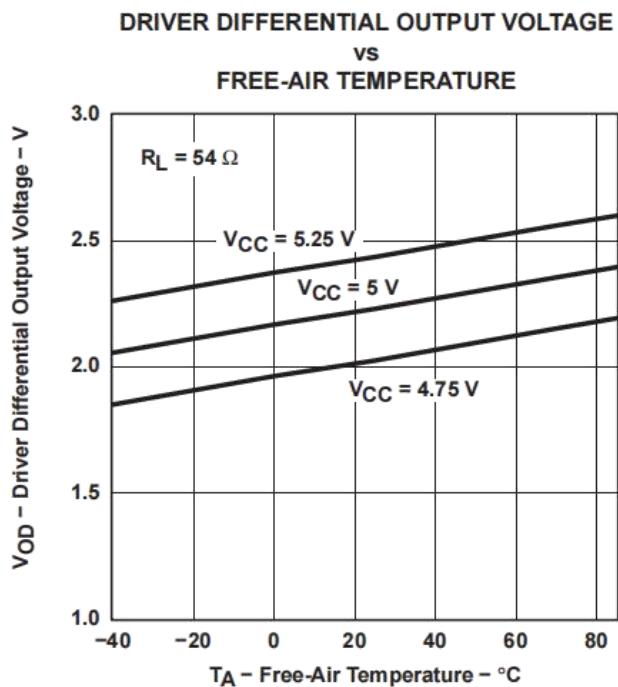
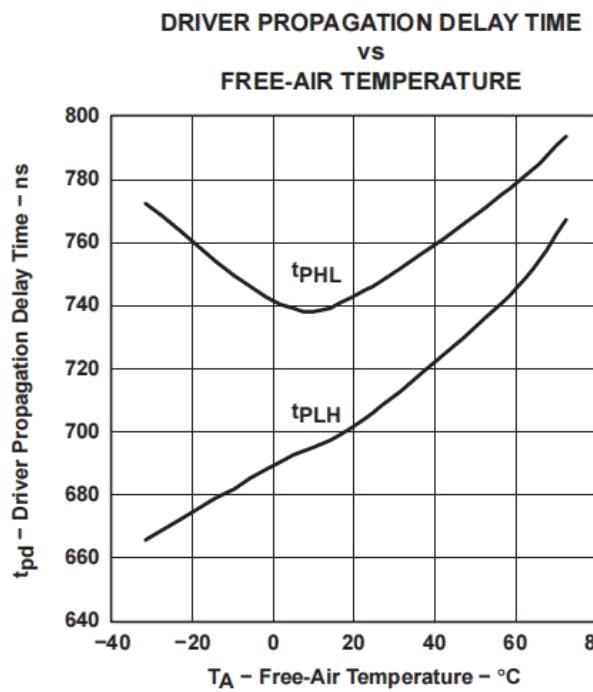
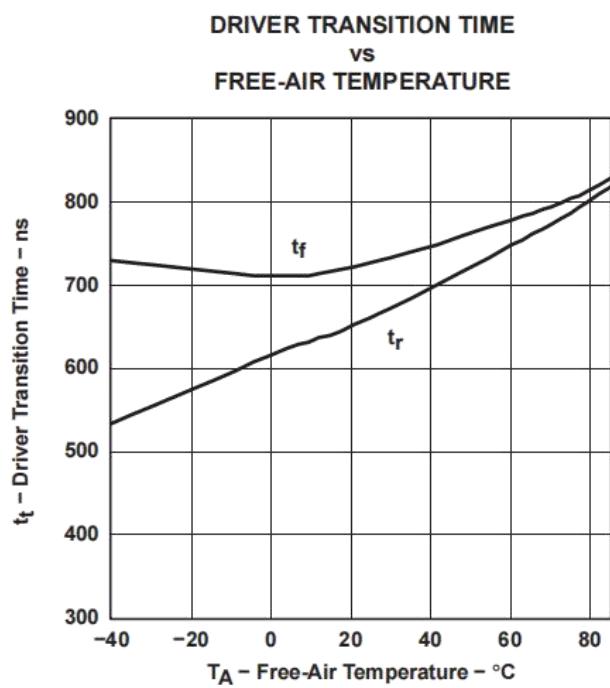
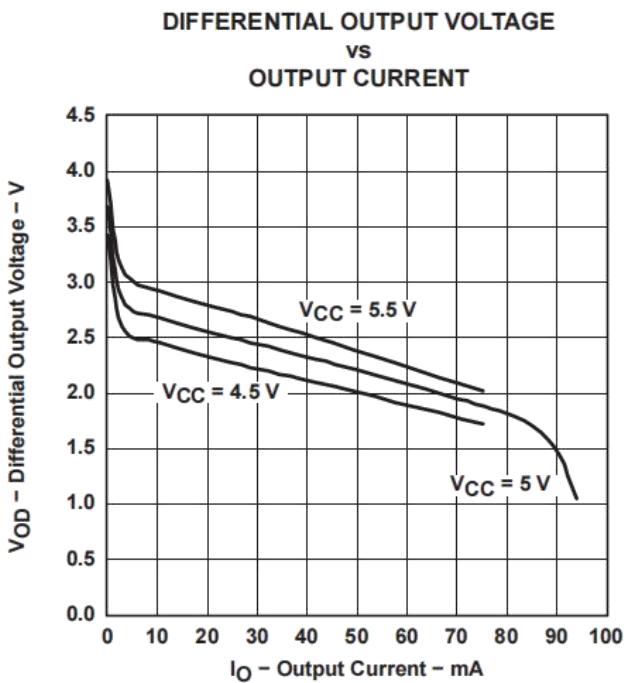
Figure 7. Receiver  $t_{PLH}$  and  $t_{PHL}$  Test Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION



NOTEA: This value includes probe and jig capacitance ( $\pm 10\%$ ).

Figure 8. Receiver  $t_{PZL}$ ,  $t_{PLZ}$ ,  $t_{PZH}$ , and  $t_{PHZ}$  Test Circuit and Voltage Waveforms

**TYPICAL CHARACTERISTICS**

**Figure 9**

**Figure 10**

**Figure 11**

**Figure 12**

## TYPICAL CHARACTERISTICS

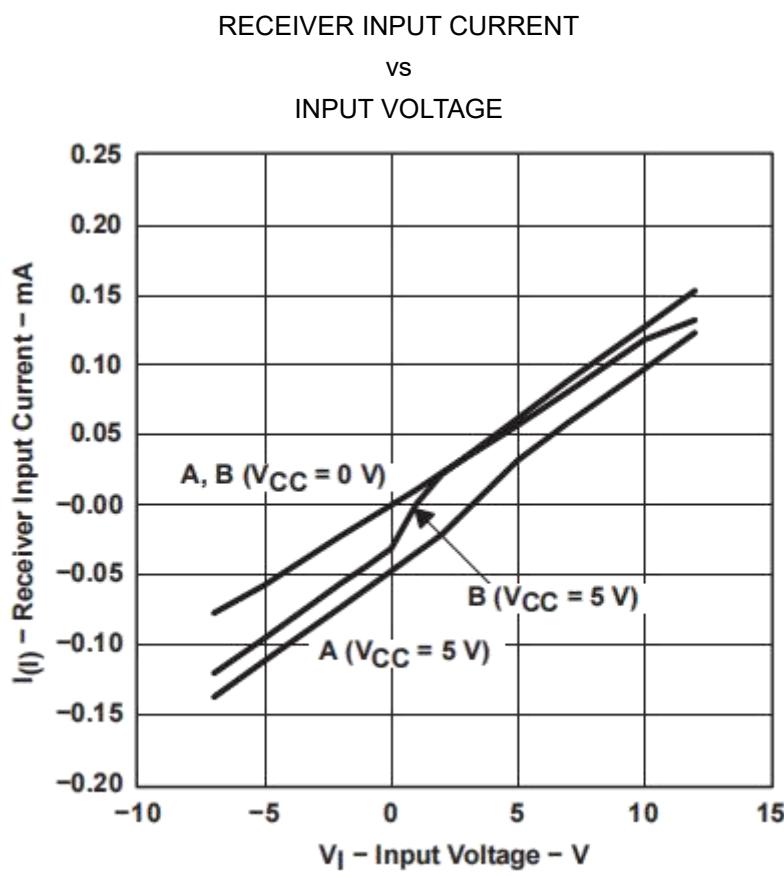
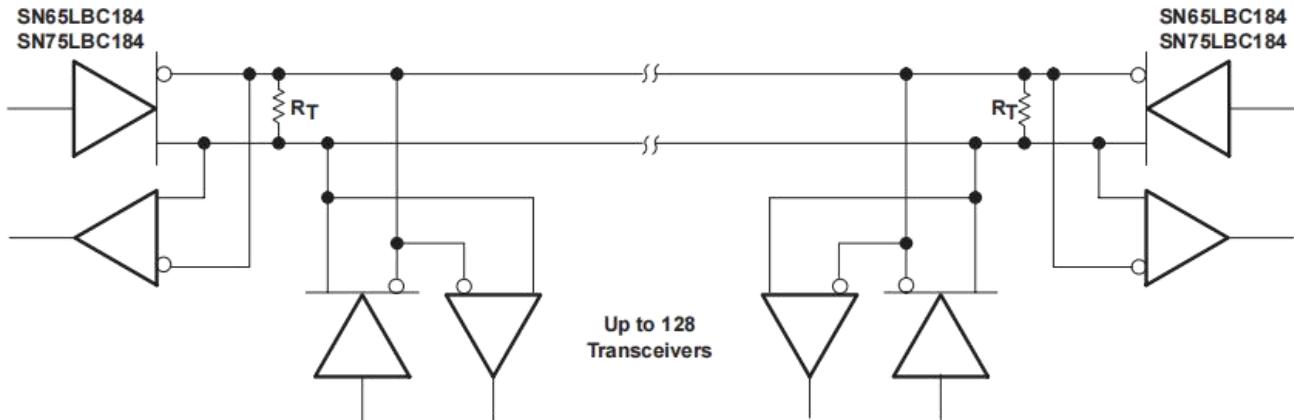


Figure 13

## APPLICATION INFORMATION



NOTE A: The line should be terminated at both ends in its characteristic impedance ( $RT = ZO$ ). Stub lengths off the main line should be kept as short as possible.

Figure 14. Typical Application Circuit

## APPLICATION INFORMATION

### 'LBC184 test description

The 'LBC184 is tested against the IEC 61000-4-5 recommended transient identified as the combination wave. The combination wave provides a 1.2-/50- $\mu$ s open-circuit voltage waveform and a 8-/20- $\mu$ s short-circuit current waveform shown in Figure 15. The testing is performed with a combination/hybrid pulse generator with an effective output impedance of 2  $\Omega$ . The setup for the overvoltage stress is shown in Figure 16 with all testing performed with power applied to the 'LBC184 circuit.

### NOTE

High voltage transient testing is done on a sampling basis.

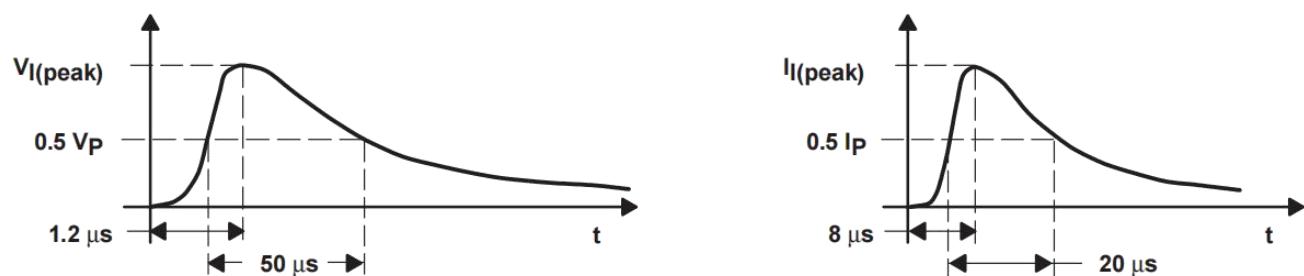


Figure 15. Short-Circuit Current Waveforms

The 'LBC184 is tested and evaluated for both maximum (single pulse) as well as life test (multiple pulse) capabilities. The 'LBC184 is evaluated against transients of both positive and negative polarity and all testing is performed with the worst-case transient polarity. Transient pulses are applied to the bus pins (A & B) across ground as shown in Figure 16.

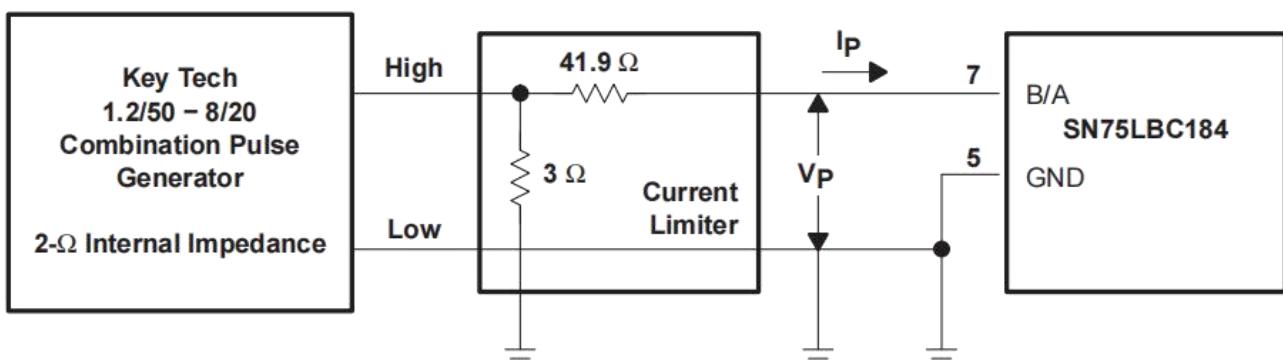


Figure 16. Overvoltage-Stress Test Circuit

An example waveform as seen by the 'LBC184 is shown in Figure 17. The bottom trace is current, the middle trace shows the clamping voltage of the device and the top trace is power as calculated from the voltage and current waveforms. This example shows a peak clamping voltage of 16 V, peak current of 33.6 A yielding an absorbed peak power of 538 W.

### NOTE

A circuit reset may be required to ensure normal data communications following a transient noise pulse of greater than 250 W peak.

APPLICATION INFORMATION

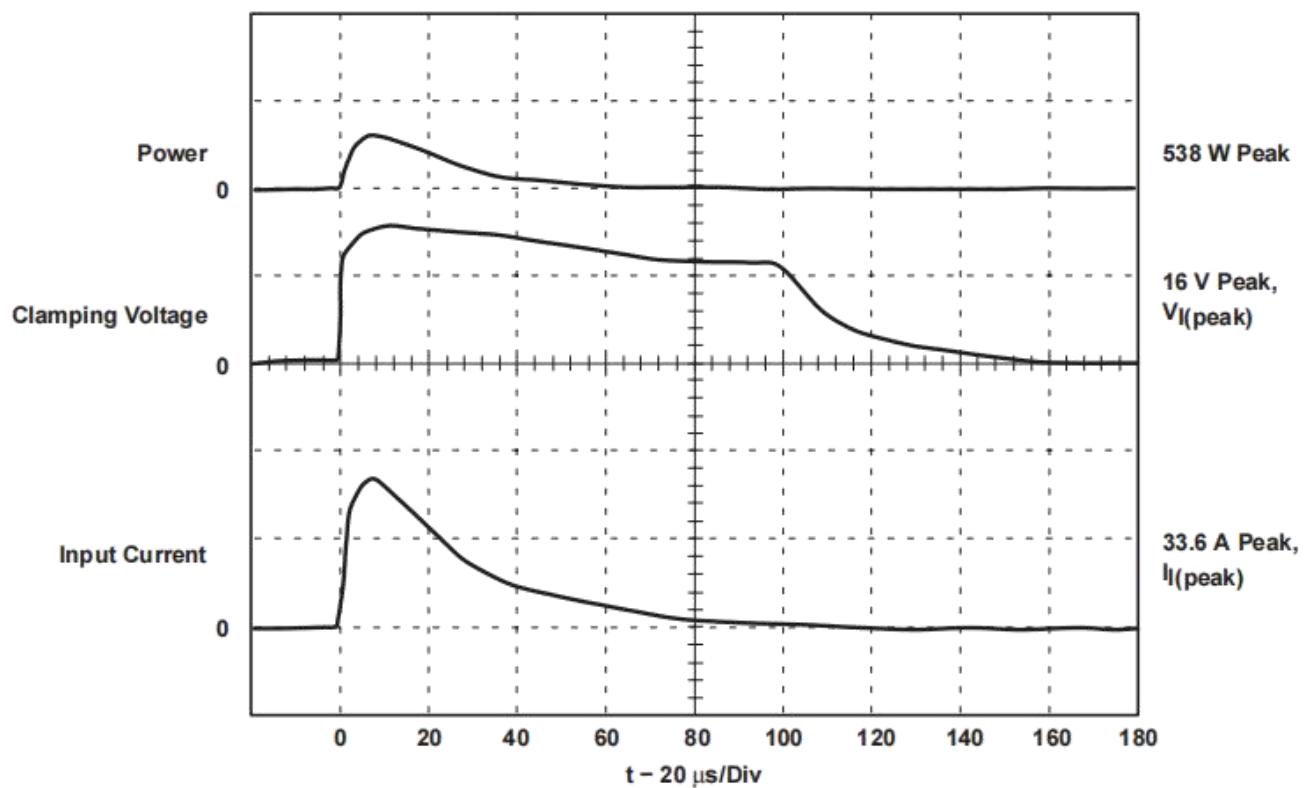
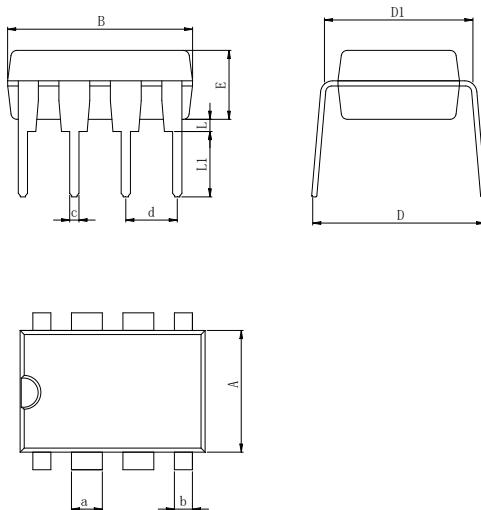


Figure 17. Typical Surge Waveform Measured At Terminals 5 and 7

## Physical Dimensions

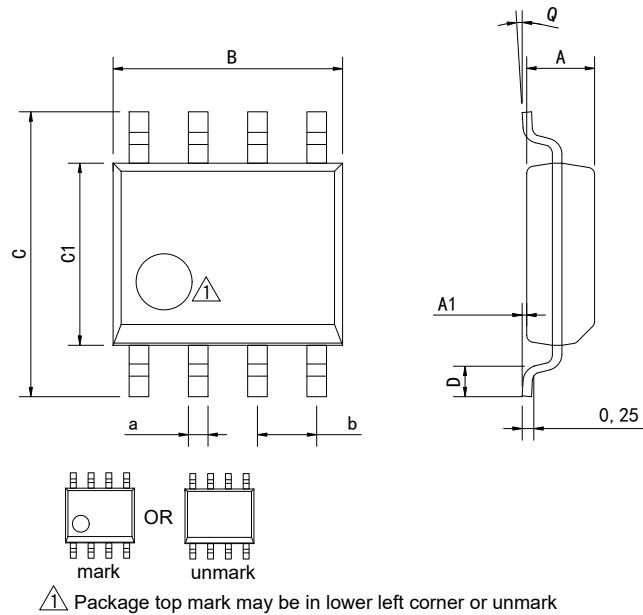
DIP-8



### Dimensions In Millimeters(DIP-8)

Symbol:	A	B	D	D1	E	L	L1	a	b	c	d
<b>Min:</b>	6.10	9.00	8.10	7.42	3.10	0.50	3.00	1.50	0.85	0.40	2.54 BSC
<b>Max:</b>	6.68	9.50	10.9	7.82	3.55	0.70	3.60	1.55	0.90	0.50	

SOP-8



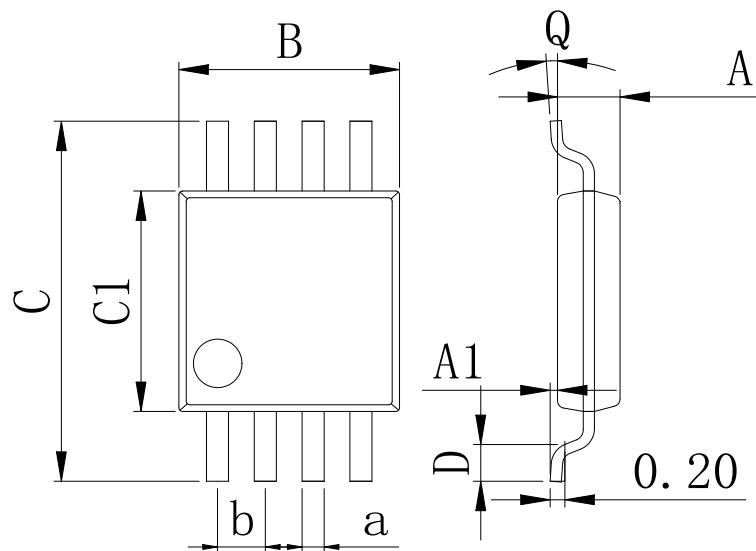
⚠ Package top mark may be in lower left corner or unmark

### Dimensions In Millimeters(SOP-8)

Symbol:	A	A1	B	C	C1	D	Q	a	b
<b>Min:</b>	1.35	0.05	4.90	5.80	3.80	0.40	0°	0.35	1.27 BSC
<b>Max:</b>	1.55	0.20	5.10	6.20	4.00	0.80	8°	0.45	

## Physical Dimensions

MSOP-8



Dimensions In Millimeters(MSOP-8)									
Symbol:	A	A1	B	C	C1	D	Q	a	b
<b>Min:</b>	0.80	0.05	2.90	4.75	2.90	0.35	0°	0.25	0.65 BSC
<b>Max:</b>	0.90	0.20	3.10	5.05	3.10	0.75	8°	0.35	

## Revision History

REVISION NUMBER	DATE	REVISION	PAGE
V1.0	2014-9	New	1-18
V1.1	2021-8	Update encapsulation type、Updated DIP-8 dimension	1、15
V1.2	2024-11	Update Lead Temperature、	4
V1.3	2025-6	Add SOP-8 package marking	1
V1.4	2025-12	Update important statements、Update SOP-8 Dimension drawing	15、18

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